TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ($L^2-\pi$ -MOSV)

2SK2399

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain–source ON resistance $: RDS (ON) = 0.17 \Omega (typ.)$ • High forward transfer admittance $: |Y_{fs}| = 4.5 S (typ.)$ • Low leakage current $: IDSS = 100 \mu A (max) (VDS = 100 V)$

• Enhancement-mode : $V_{th} = 0.8 \sim 2.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	100	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	100	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	I _D	5	Α
Drain current	Pulse (Note 1)	I _{DP}	20	Α
Drain power dissipatio	n (Tc = 25°C)	P _D	20	W
Single pulse avalanche	e energy (Note 2)	E _{AS}	180	mJ
Avalanche current		I _{AR}	5	Α
Repetitive avalanche	energy (Note 3)	E _{AR}	2	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature range		T _{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

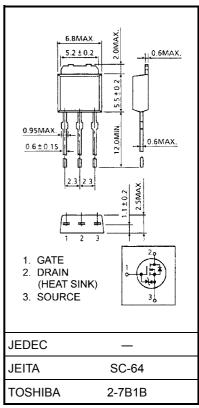
Note 2: V_{DD} = 25 V, T_{ch} = 25 °C (initial), L = 11.6 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

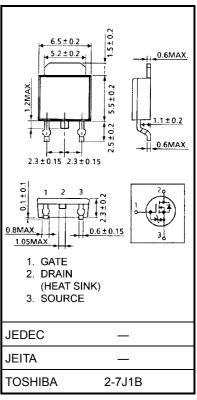
This transistor is an electrostatic sensitive device.

Please handle with caution.

Unit: mm



Weight: 0.36 g (typ.)



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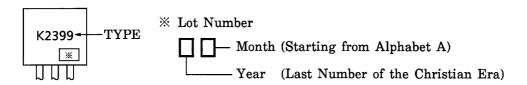
Electrical Characteristics (Ta = 25°C)

Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ	
Drain cut-off cu	rent	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	_	_	100	μΑ	
Drain-source br voltage	eakdown	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	100	_	_	V	
Gate threshold v	roltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	8.0	_	2.0	V	
Drain-source O	N registance	-	V _{GS} = 4 V, I _D = 2.5 A	_	0.22	0.30	Ω	
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	_	0.17	0.23	1 1	
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.0	4.5	_	S	
Input capacitano	е	C _{iss}		_	500	_		
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	80	_	pF	
Output capacitance		C _{oss}			190	_		
Switching time	Rise time	t _r	V _{GS} 10V I _D =2.5A OVOUT	_	17	_		
	Turn-on time	t _{on}	$\begin{array}{c c} & & & & \\ & &$		25		ne	
	Fall time	t _f	<i>#</i> # 6	_	50		ns	
	Turn-off time	t _{off}	$V_{DD} = 50V$ Duty $\leq 1\%$, $t_{W} = 10 \mu s$	_	195	_		
Total gate charge (Gate-source plus gate-drain)		Qg		_	22	_		
Gate-source charge		Q _{gs}	$V_{DD} \approx 80 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		15	_	nC	
Gate-drain ("miller") charge		Q_{gd}		_	7	_		

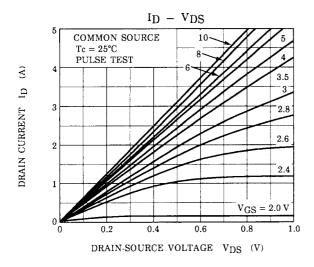
Source-Drain Ratings and Characteristics (Ta = 25°C)

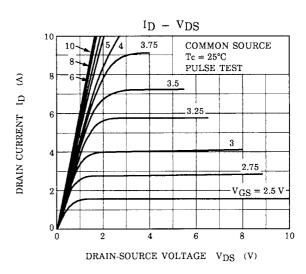
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_		_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_		_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	-I _{DR} = 5 A, V _{GS} = 0 V, dI _{DR} / dt = 50 A / μs	_	160	_	ns
Reverse recovery charge	Q _{rr}		-	0.28	_	μC

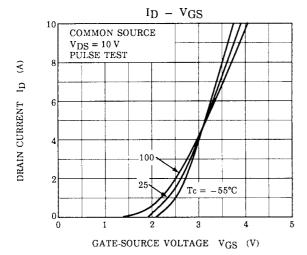
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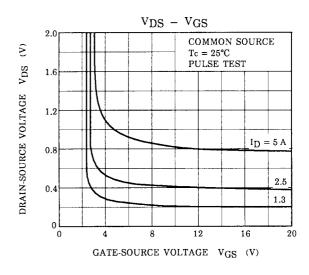


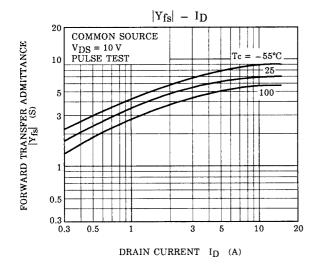
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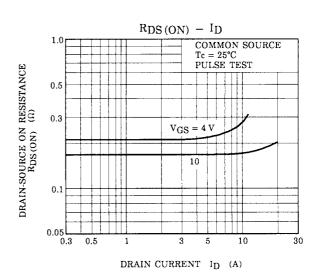




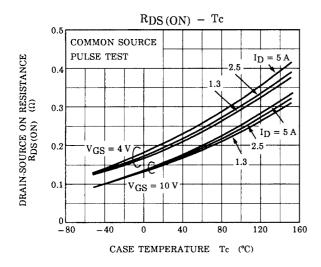


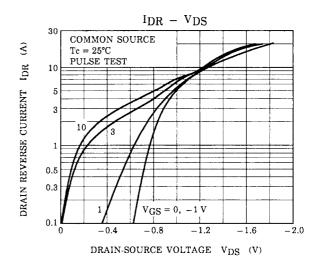


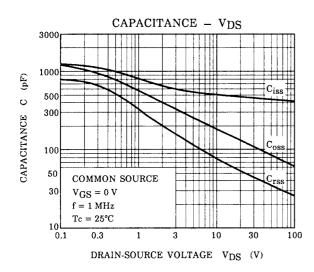


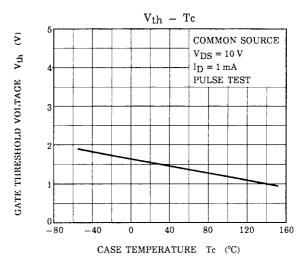


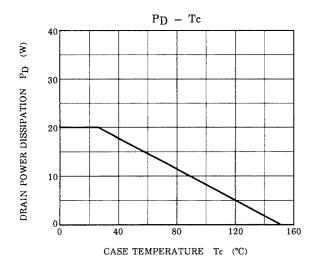
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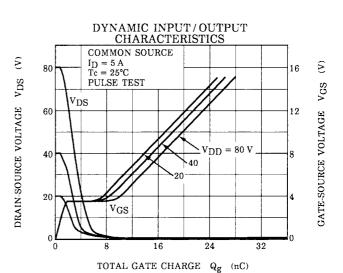




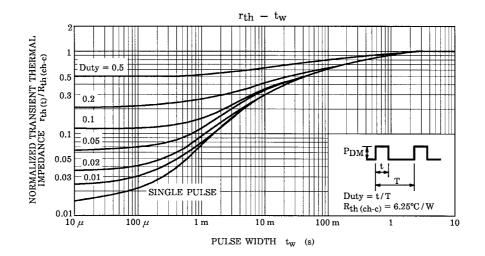


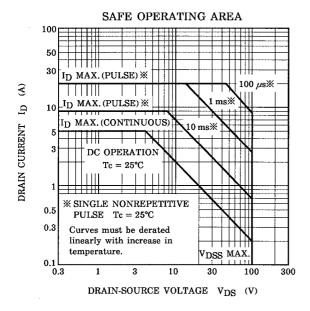


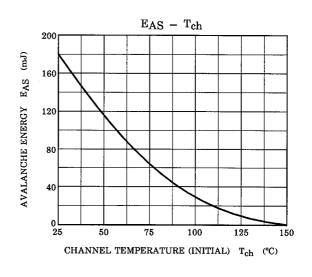


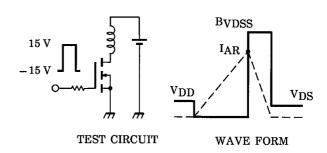


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$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 25~V,~L = 11.6~mH \end{aligned} \qquad E_{AS} &= \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right) \end{aligned}$$

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